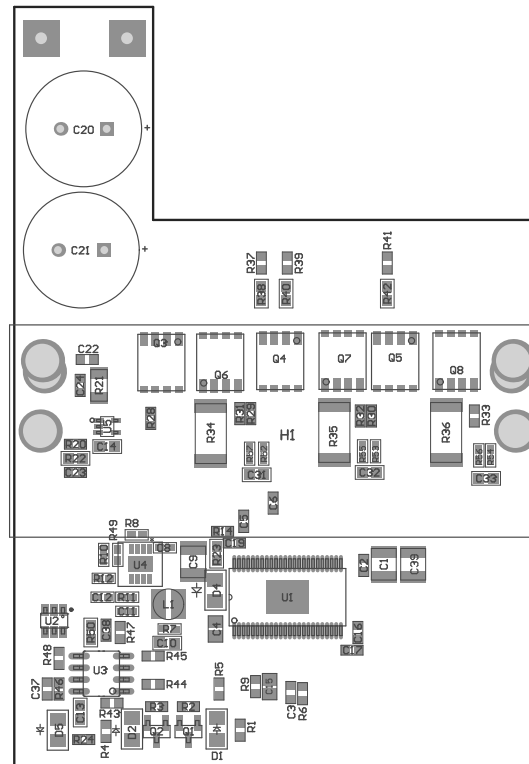
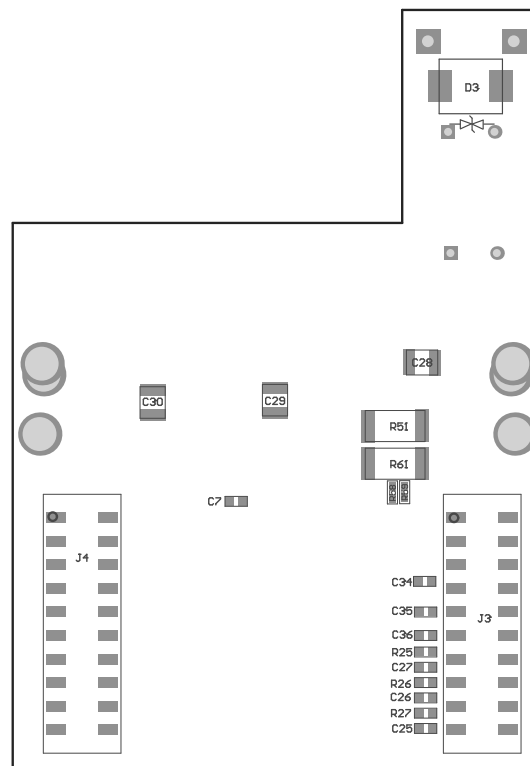


ZZ4 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
 ZZ3 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
 ZZ2 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 002

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00436	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = ASSEMBLY TOP			
PLOT NAME = Top Assembly Drawing	GENERATED : 3/13/2015	5:34:41 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 002

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00436	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = ASSEMBLY BOTTOM			
PLOT NAME = Bottom Assembly Drawing	GENERATED : 3/13/2015	5:34:41 PM	TEXAS INSTRUMENTS

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